

Signal Detection Circuit

RELATED APPLICATIONS

This application claims the benefit of priority pursuant to 35 USC §119(e) from U.S. provisional patent application Ser. No. 60/445,751, filed February 7, 2003, and entirely incorporated herein by reference.

BACKGROUND OF THE INVENTION

This invention relates to semiconductor integrated circuits and, more particularly, to a signal detection circuit. The function of the signal detection circuit is to compare an amplitude of a differential input signal to a comparator threshold voltage and to produce an output signal which is either high or low depending on whether the signal's amplitude is less than or greater than the comparator threshold voltage. This invention is similar to a method of detecting an amplitude of a signal which uses a current-source-biased comparator, but replaces the current source with a short to a power supply terminal and adds input signal level-shifters, providing for a much-improved differential input signal common-mode range.

Fig. 1 is a schematic diagram illustrating a signal detection circuit of the prior art. A differential input signal comprises input signals INP and INM, with INP coupled to the gate terminal of M8, and INM coupled to the gate terminal of M9. A compare voltage THRESH, coupled to a gate terminal of M4, is set to a voltage equal to an average of INP and INM plus the comparator threshold voltage. The drain terminals of M8 and M9 are coupled together and to output terminal OUT1, and the source terminals of M4, M8, and M9 are coupled together and to current source I1. A current mirror comprising M6 and M7 has an input coupled to the drain of M4 and an output coupled to OUT1. N-type transistors M4, M8, and M9 are of equal size, and p-type transistors M6 and M7 are of equal size. When the amplitude of the differential input signal exceeds the comparator threshold voltage, input signal INP or INM is more positive than THRESH, and output terminal OUT1 will then be substantially low, indicating detection of the differential input signal. When the amplitude of the differential input signal is less than the comparator threshold voltage, input signal INP or INM is always more negative than THRESH, and output terminal OUT1 will then be substantially high. For most practical values of the

compare voltage THRESH, during a transition of the differential input signal from one state to another (for example, from a “one” state to a “zero” state), OUT1 may tend to momentarily pulse from a low to a high voltage and then return to a low voltage when the transition is complete. In one embodiment, this pulse is inhibited with a capacitor coupled to OUT1.

SUMMARY OF THE INVENTION

To compare the amplitude of a differential input signal to a comparator threshold voltage, a signal detection circuit includes first and second matched input signal level-shifters, a compare voltage generation circuit, and a two-stage comparator. The differential input signal is comprised of a true input signal and a complement input signal, and the first input signal level-shifter is coupled to the true input signal, and the second input level-shifter is coupled to the complement input signal. The compare voltage generation circuit outputs a first compare voltage set to an average voltage of the output signals of the level-shifters plus the comparator threshold voltage, and a second compare voltage set to the average voltage of the output signals of the level-shifters minus the comparator threshold voltage. The first stage of the two-stage comparator outputs a low signal if the more positive of the level-shifted input signals is greater than the more positive of the compare voltages. The second stage of the two-stage comparator amplifies the output of the first stage of the two-stage comparator, includes positive feedback to inhibit comparator self-oscillation, and has a sufficiently low bandwidth so as not to pass to its output a momentary pulse at its input due to a transition in the differential input signal.

BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a schematic diagram of a prior-art signal detection circuit.

Fig. 2 is a schematic diagram of components of a signal detection circuit in accordance with one embodiment of the present invention.

Fig. 3 is a waveform diagram illustrating operation of the signal detection circuit of Fig. 2.

Fig. 4 is a schematic diagram of the signal detection circuit with additional components, in accordance with the present invention.

Fig. 5 is a schematic diagram of a differential to single-ended amplifier, in accordance with the present invention.

Fig. 6 is a schematic diagram of a logic inverter, in accordance with the present invention.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

The signal detection circuits of Fig. 2 illustrate components of one embodiment of the invention. Fig. 2a shows input signal level-shifters 5 and a matched circuit 6 which sets the voltage of a common signal to that of the average voltage of the input signal level-shifter output signals. Also included are level-shifting voltage sources 7 referenced to the common signal which assist in setting the compare voltages for the two-stage comparator illustrated in Fig. 2b.

The differential input signal is comprised of input signals INP and INM, which are coupled to the matched input signal level-shifters. Input signal INP is coupled to level-shifted signal INPX through series components R1 and C1. A level-shift current from transistor M1 induces a voltage drop across R1, and capacitor C1 provides a low-impedance signal path to couple INP to INPX with minimal high-frequency signal loss. Similarly, input signal INM is coupled to level-shifted signal INMX through series components R2 and C2, and a level-shift current from transistor M2 sets a voltage drop across R2, and capacitor C2 provides a low-impedance signal path to couple INM to INMX with minimal high-frequency signal loss. These two level-shifters are matched: R1 and R2 are the same size and resistance value, C1 and C2 are the same size and capacitance value, and M1 and M2 are the same size and have matched K-factors (voltage-to-current conversion gain).

The matched circuit sets the voltage of the common signal COM to that of the average voltage of INPX and INMX, and comprises resistors R3 and R4, and transistor M3. In a

preferred embodiment, resistors **R1**, **R2**, **R3**, and **R4** are the same size and value, the gate width of **M3** is twice the gate width of **M1** and **M2** (or, alternatively, **M3** comprises two transistors matched to **M1** and **M2**), and the gate lengths of **M1**, **M2**, and **M3** are equal. Two final components of the circuit of Fig. 2a are level-shifting voltage sources **V1** and **V2**. In a preferred embodiment, **V1** and **V2** are each set to a voltage equal to the comparator threshold voltage.

Fig. 2b depicts the two-stage comparator, comprising a first comparator 8 and a second comparator 9. A first dual-input voltage-to-current converter comprised of transistors **M4** and **M5** has an output and its inputs are coupled to compare voltages THRESHP and THRESHM. A second dual-input voltage-to-current converter comprised of transistors **M8** and **M9** has an output coupled to OUT1, and its inputs are coupled to level-shifted signals INPX and INMX. A current mirror comprised of transistors **M6** and **M7** has an input coupled to the output of the first dual-input voltage-to-current converter and an output coupled to OUT1 and to an input of the second comparator. Coupled to a second input of the second comparator is a threshold voltage THRESH.

Fig. 3 illustrates the functionality of the circuits of Fig. 2. Waveforms labeled INP, INM, THRESHP, THRESHM, INPX, INMX, COM, THRESH, OUT1, and OUT2 depict signals at nodes of Fig. 2 having the same designations. In this illustration, the amplitude of differential signal INP-INM diminishes over time until below a threshold, at which time OUT1 and OUT2 each transition from a low level to a high level. The first comparator takes advantage of a square-law dependence of voltage-to-current conversion gain of transistors **M4**, **M5**, **M8**, and **M9**.

Consider currents I1 and I2 of Fig. 2 flowing through transistors **M4** and **M5**, and transistors **M8** and **M9**, respectively, given by the equations

$$I1 = K_{M4}(V_{GS,M4} - V_{T,M4})^2 + K_{M5}(V_{GS,M5} - V_{T,M5})^2 \quad (1)$$

$$I2 = K_{M8}(V_{GS,M8} - V_{T,M8})^2 + K_{M9}(V_{GS,M9} - V_{T,M9})^2 \quad (2)$$

Each of the constants K_{Mn} and $V_{T,Mn}$ ($n=4,5,8,9$) represent a transistor's K-factor (voltage-to-current conversion gain) and threshold voltage, respectively. In a preferred embodiment, and for the purposes of simplifying the following analysis, the gate length of all transistors of Fig. 2 are equal, the gate widths of **M1** and **M2** are equal, the gate width of **M3** is twice that of **M1** and **M2** (or, alternatively, **M3** comprises first and second transistors matched to **M1** and **M2**, respectively), the gate widths of **M4**, **M5**, **M8**, and **M9** are equal, and the gate widths of **M6** and

M7 are equal. Additionally, resistors **R1**, **R2**, **R3**, and **R4** are equal in resistance value. It is further assumed that all the transistor K-factors are equal and are equal to K and that all the transistor threshold voltages are equal and are equal to V_T . With a current gain of the current mirror substantially equal to one because **M6** and **M7** are of equal size, the voltage of OUT1 will be substantially near VDD when $I1 > I2$ and near VSS when $I1 < I2$. With voltage sources **V1** and **V2** set to comparator threshold voltage V_1 , the following relations are evident from Fig. 2:

$$V_{GS,M4} = V_{THRESHP} - V_{VSS} \quad (3)$$

$$V_{GS,M5} = V_{THRESHM} - V_{VSS} \quad (4)$$

$$V_{GS,M8} = V_{INPX} - V_{VSS} \quad (5)$$

$$V_{GS,M9} = V_{INMX} - V_{VSS} \quad (6)$$

$$V_{THRESHP} = V_{COM} + V_1 \quad (7)$$

$$V_{THRESHM} = V_{COM} - V_1 \quad (8)$$

Defining V_{PEAK} as a peak voltage of signals INP and INM above average voltage $(V_{INP} + V_{INM})/2$, and with a voltage drop across each of level-shifting resistors **R1-R4** being substantially equal, the following relations are true:

$$V_{INPX} = V_{COM} + V_{PEAK} \quad (9)$$

$$V_{INMX} = V_{COM} - V_{PEAK} \quad (10)$$

Combining equations (1) through (10) gives the following result:

$$I2 - I1 = 2K(V_{PEAK}^2 - V_1^2) \quad (11)$$

The signal detection circuit is operating at a threshold when $I1 = I2$. When $I1 > I2$, a net positive current will charge OUT1 to a voltage substantially near VDD, and when $I1 < I2$, a net negative current will discharge OUT1 to a voltage substantially near VSS. A condition for which the first comparator is at its threshold is given by that voltage of V_{PEAK} for which $I2 - I1 = 0$, and is obtained by inspection as $V_{PEAK} = V_1$, thereby confirming the proper definition of V_1 as the comparator threshold voltage.

Finally, it is instructive to differentiate equation (11):

$$\partial(I2 - I1) / \partial V_{PEAK} = 4KV_1 \quad (12)$$

The quantity $4KV_1$ is a measure of the first comparator's voltage-to-current gain, and this gain is a non-zero quantity if $V_1 \neq 0$. In all practical applications of this signal detection circuit, this is indeed the case.

Fig. 4 illustrates a detailed schematic of the complete signal detection circuit.

Fig. 4a illustrates the circuit of Fig. 2a, but with voltage sources V1 and V2 removed.

Fig. 4b illustrates the circuit of Fig. 2b, but includes transistors M18 and M19 used to set threshold voltage THRESH, and also includes transistors M16 and M17 and inverter U3 so as to provide positive feedback to the operation of the second comparator. This last addition inhibits comparator self-oscillation when operating near threshold for an extended period of time.

Fig. 4c illustrates a circuit which implements the functionality of voltage sources V1 and V2 of Fig. 2a, and comprises bias generator 15, switched current-source 16, and current-to-voltage converter 17. Bias generator 15 consists of a resistor string made from R8-R11, used to generate reference voltage REF, and a feedback circuit consisting of differential-to-single-ended amplifier U4, transistor M10, and reference resistor R7. Negative feedback forces feedback reference node voltage V_{FBREF} to be substantially equal to V_{REF} . It then follows that current through M10 and R7 is given by

$$I_{M10} = I_{R7} = (V_{VDD} - V_{REF})/R_{R7} \quad (13)$$

Switched current-source 16 is a binary-weighted switched current source and is comprised of dual-gate transistors M20, M21, M22, and M23. In a preferred embodiment, these dual-gate transistors each consist of two series transistors having a gate width and an equal gate length. The gate width of the transistors of dual-gate transistor M22 is twice that of the transistors of dual-gate transistor M23; the gate width of the transistors of dual-gate transistor M21 is twice that of the transistors of dual-gate transistor M22; and the gate width of the transistors of dual-gate transistor M20 is twice that of the transistors of dual-gate transistor M21. Additionally, the gate width of transistor M10 is twice the gate width of the transistors of dual-gate transistor M20. In combination, bias generator 15 and switched current-source 16 form a binary-weighted, programmable current source controlled by logic terminals IN0, IN1, IN2, and IN3 and having an output current given by

$$I_X = (IN/16) * I_{M10} \quad (14)$$

where IN is a decimal number between 0 and 15 and is set by logic levels IN[3:0].

Current-to-voltage converter 17 comprises three current mirrors each with a gain substantially equal to 1, and resistors R5 and R6. A first current mirror comprising M11 and M12 generates output current I_{12} equal to input current I_X ; a second current mirror comprising

M11 and **M13** generates output current I_{13} equal to input current I_X ; and a third current mirror comprising **M14** and **M15** generates output current I_{15} equal to input current I_{12} . It then follows that compare voltages $V_{THRESHP}$ and $V_{THRESHM}$ are given by

$$V_{THRESHP} = V_{COM} + I_X \cdot R_{R5} \quad (15)$$

$$V_{THRESHM} = V_{COM} - I_X \cdot R_{R6} \quad (16)$$

In a preferred embodiment, all resistors of Fig. **4c** are of equal value, and equations (13)-(16) can then be combined and simplified to obtain

$$V_{THRESHP} = V_{COM} + V_1 \quad (17)$$

$$V_{THRESHM} = V_{COM} - V_1 \quad (18)$$

$$\text{where } V_1 = (V_{VDD}/4) \cdot (IN/16) \quad (19)$$

This final equation (19) illustrates the influence of logic terminals IN[3:0] on the comparator threshold voltage, V_1 .

Fig. **5** illustrates the differential to single-ended amplifier, instantiated as **U1** in Fig. **2b**, as **U2** in Fig. **4b**, and as **U4** in Fig. **4c**, and is comprised of transistors **M1-M9**. Transistor **M1** is a resistive current source which biases differential transistor pair **M2** and **M3**. The drain of **M2** is coupled to output OUT through two series current mirrors comprising p-type transistors **M4** and **M6**, and n-type transistors **M7** and **M8**. The drain of **M3** is coupled to OUT through a single current mirror comprising p-type transistors **M5** and **M9**. In a preferred embodiment, the gate lengths of all transistors but **M1** are the same, the gate width of n-type transistors **M2**, **M3**, **M7**, and **M8** are the same, and the gate width of p-type transistors **M4**, **M5**, **M6**, and **M9** are the same. Additionally, the gate width of n-type transistor **M1** is equal to the gate width of the other n-type transistors, and the gate length of **M1** is at least 5 times longer than the gate length of the other n-type transistors. In **U2**, so as to prevent false switching at its output when the differential input signals transition from low to high or from high to low, the gate length of **M1** is increased to 10 times (or more) that of the gate length of the other n-type transistors, for the purpose of decreasing the bandwidth and switching speed of **U2**.

Fig. **6** illustrates logic inverter **U3** of Fig. **4b**, used to facilitate positive feedback to inhibit comparator self-oscillation. The logic inverter comprises n-type transistor **M20** and p-type transistor **M21**. The gate of each transistor is coupled to input IN, and the drain of each transistor is coupled to output OUT.

The signal detection circuit can be implemented with discreet components, with semiconductor devices embedded in an integrated circuit such as an application specific integrated circuit (ASIC), or with a combination of both. Individual signals or devices can be active high or low, and corresponding circuitry can be converted or complemented to suit any particular convention. The term "coupled" used in the claims includes various types of connections or couplings and includes a direct connection or a connection through one or more intermediate components. Except to the extent specified in the following claims, circuit configurations and device sizes shown herein are provided as examples only. Those skilled in the art will recognize that desired and proper circuit operation can be achieved with other circuit configurations, device sizes, and/or combinations of device sizes.